

SinglFuse™ SF-1206F Series Features

- Single blow fuse for overcurrent protection
- 3216 (EIA 1206) miniature footprint
- Fast acting fuse
- UL listed
- RoHS compliant* and halogen free**
- Thin film chip fuse
- Surface mount packaging for automated assembly

SF-1206F Series - Fast Acting Surface Mount Fuses

Electrical Characteristics

| Model | Rated Current (Amps) | Fusing Time | Resistance (mΩ) Typ.*** | Rated Voltage | Breaking Capacity | Typical I ² t (A ² s) |
|-------------|----------------------|---|-------------------------|---------------|-------------------|---|
| SF-1206F050 | 0.50 | Open within 1 min. at 200 % rated current | 590 | DC 63 V | DC 63 V 50 A | 0.011 |
| SF-1206F080 | 0.80 | | 225 | | | 0.031 |
| SF-1206F100 | 1.00 | | 130 | | | 0.034 |
| SF-1206F125 | 1.25 | | 88 | | | 0.062 |
| SF-1206F150 | 1.50 | | 65 | | | 0.144 |
| SF-1206F200 | 2.00 | | 38 | DC 32 V | DC 32 V 50 A | 0.181 |
| SF-1206F250 | 2.50 | | 32 | | | 0.351 |
| SF-1206F300 | 3.00 | | 23 | DC 24 V | DC 24 V 50 A | 0.501 |
| SF-1206F400 | 4.00 | | 15 | | | 0.954 |
| SF-1206F500 | 5.00 | | 11 | | | 0.966 |
| SF-1206F700 | 7.00 | 7 | | | 3.25 | |

***Resistance value was measured with less than 10 % of rated current.

Reliability Testing

| Parameter | Requirement | Test Method |
|---------------------------|---------------------------------|---|
| Carrying Capacity | No fusing | Rated current, 4 hours |
| Fusing Time | Within 1 minute | 200 % of its rated current |
| Interrupting Ability | No mechanical damages | After the fuse is interrupted, rated voltage applied for 30 seconds again |
| Bending Test | No mechanical damages | Distance between holding points: 90 mm, Bending: 3 mm, 1 time, 30 seconds |
| Resistance to Solder Heat | ±20 % | 260 °C ±5 °C, 10 seconds ±1 second |
| Solderability | 95 % coverage minimum | 235 °C ±5 °C, 2 ±0.5 second 245 °C ±5 °C, 2 ±0.5 second (lead free) |
| Temperature Rise | <75 ° | 100 % of its rated current, measure of surface temperature |
| Resistance to Dry Heat | ±20 % | 105 °C ±5 °C, 1000 hours |
| Resistance to Solvent | No evident damage on protective | 23 °C ±5 °C of isopropyl alcohol, 90 seconds coating and marking |
| Residual Resistance | 10k W or more | Measure DC resistance after fusing |
| Thermal Shock | DR < 10 % | -20 °C / +25 °C / +125 °C / +25 °C, 10 cycles |

Typical Part Marking

Represents total content. Layout may vary.



RATING CURRENT (A)
 F = 0.50 T = 2.50
 K = 0.80 3 = 3.00
 L = 1.00 W = 4.00
 M = 1.25 Y = 5.00
 P = 1.50 Z = 7.00
 S = 2.00

How to Order

SF - 1206 F 050 - 2

SinglFuse™
 Product Designator

SMD Footprint
 3216 (1206) size

Fuse Blow Type
 F = Fast acting
 S = Slow blow

Rated Current
 050-700 (500 mA - 7.00 A)

Packaging Type
 - 2 = Tape & Reel (5,000 pcs./reel)

BOURNS®

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* RoHS Directive 2002/95/EC Jan 27 2003 including Annex.

** Bourns is using the definition that appears to be the prevalent definition used as the industry standard at this time. The Bourns definition of "halogen-free" is: Bromine (Br) content: ≤ 900 ppm; Chlorine (Cl) content: ≤ 900 ppm; Total Br + Cl content: ≤ 1500 ppm.

"SinglFuse" is a trademark of Bourns, Inc.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

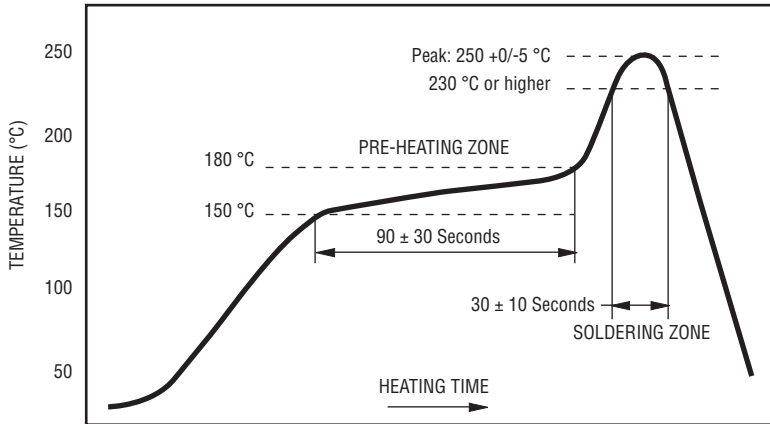
Users should verify actual device performance in their specific applications.

SinglFuse™ SF-1206F Series Applications

- Portable memory
- LCD monitors
- Disk drives
- PDAs
- Digital cameras
- DVDs
- Cell phones
- Rechargeable battery packs
- Battery chargers
- Set top boxes
- Industrial controllers

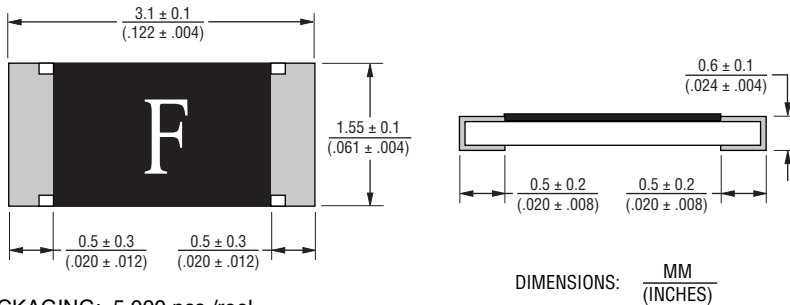
SF-1206F Series - Fast Acting Surface Mount Fuses BOURNS®

Solder Reflow Recommendations



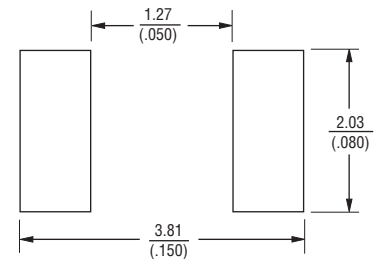
PEAK: 250 +0/-5 °C, 5 seconds
 PRE-HEATING ZONE: 150 to 180 °C, 90 ± 30 seconds
 SOLDERING ZONE: 230 °C or higher, 30 ± 10 seconds

Product Dimensions



PACKAGING: 5,000 pcs./reel

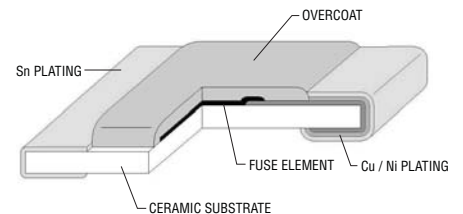
Recommended Pad Layout



Thermal Derating Curve



Construction & Material Content



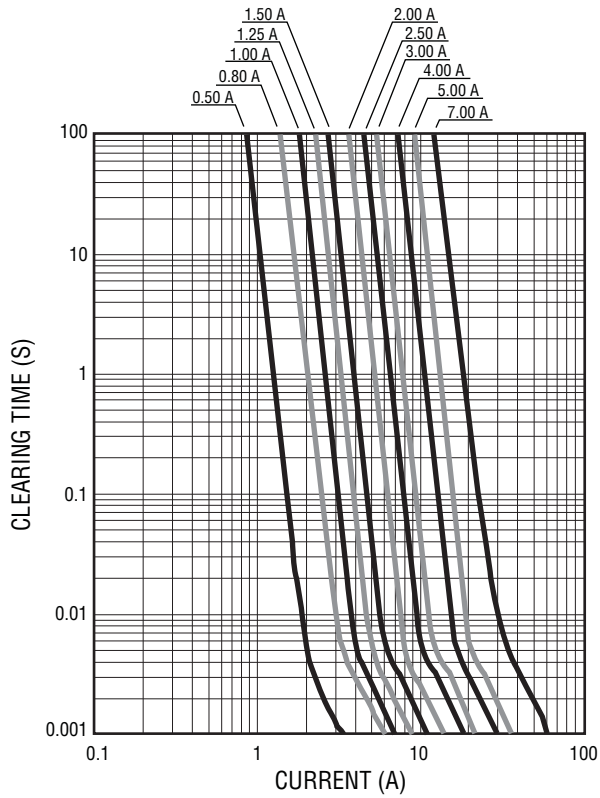
Operating Temperature.....-40 °C to +105 °C
 Storage Conditions
 Temperature+5 °C to +35 °C
 Humidity.....40 % to 75 %
 Shelf Life..... 2 years from manufacturing date

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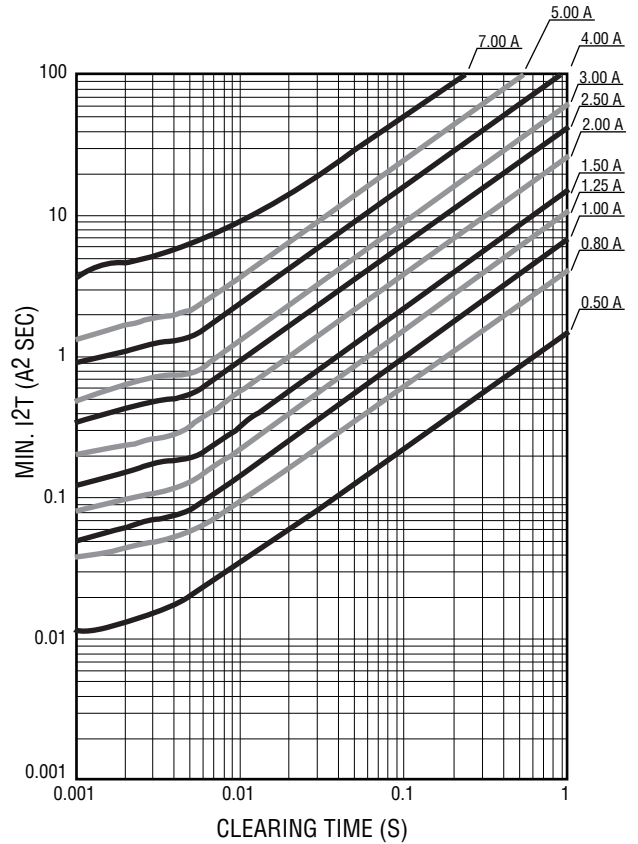
SF-1206F Series - Fast Acting Surface Mount Fuses

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Average Time Current Curves



Minimum I²T V Clear Time Curves



REV. D 03/13

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SF-1206F Series Tape and Reel Specifications

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| Tape Dimensions | SF-1206F Series per EIA 481-2 |
|------------------------|---|
| W | $\frac{8.0 \pm 0.2}{(.315 \pm .008)}$ |
| P ₀ | $\frac{4.0 \pm 0.1}{(.157 \pm .004)}$ |
| P ₁ | $\frac{4.0 \pm 0.1}{(.157 \pm .004)}$ |
| P ₂ | $\frac{2.0 \pm 0.05}{(.079 \pm .002)}$ |
| A | $\frac{2.0 \pm 0.15}{(.079 \pm .006)}$ |
| B | $\frac{3.6 \pm 0.2}{(.142 \pm .008)}$ |
| F | $\frac{3.5 \pm 0.05}{(.138 \pm .002)}$ |
| E | $\frac{1.75 \pm 0.1}{(.069 \pm .004)}$ |
| D ₀ | $\frac{1.5 + 0.1/-0}{(.059 + .004/-0)}$ |
| T | $\frac{0.84 \pm 0.1}{(.033 \pm .004)}$ |
| Reel Dimensions | |
| A | $\frac{180 +0/-3.0}{(7.087 +0/-1.18)}$ |
| B Min. | $\frac{60.0}{(2.362)}$ |
| C | $\frac{13.0 \pm 1.0}{(.512 \pm .039)}$ |
| W | $\frac{9.0 \pm 1.0}{(.354 \pm .039)}$ |
| T | $\frac{11.4 \pm 2.0}{(.449 \pm .079)}$ |



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Данный компонент на территории Российской Федерации

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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